

PDTA124X series

PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 47 k Ω

Rev. 08 — 3 September 2009

Product data sheet

1. Product profile

1.1 General description

PNP Resistor-Equipped Transistors (RET) family.

Table 1. Product overview

| Type number | Package | | | NPN complement |
|--------------------------|---------|--------|----------|----------------|
| | NXP | JEITA | JEDEC | |
| PDTA124XE | SOT416 | SC-75 | - | PDTC124XE |
| PDTA124XEF | SOT490 | SC-89 | - | PDTC124XEF |
| PDTA124XK | SOT346 | SC-59A | TO-236 | PDTC124XK |
| PDTA124XM | SOT883 | SC-101 | - | PDTC124XM |
| PDTA124XS ^[1] | SOT54 | SC-43A | TO-92 | PDTC124XS |
| PDTA124XT | SOT23 | - | TO-236AB | PDTC124XT |
| PDTA124XU | SOT323 | SC-70 | - | PDTC124XU |

[1] Also available in SOT54A and SOT54 variant packages (see [Section 2](#))

1.2 Features

- Built-in bias resistors
- Simplifies circuit design
- 100 mA output current capability
- Reduces component count
- Reduces pick and place costs

1.3 Applications

- Digital applications
- Controlling IC inputs
- Cost-saving alternative for BC857 series in digital applications
- Switching loads

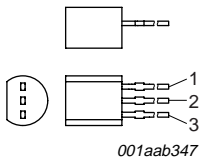
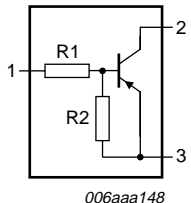
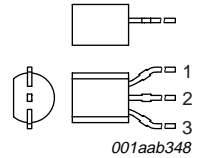
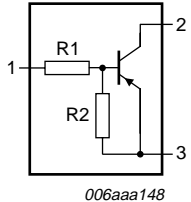
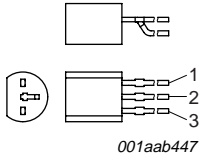
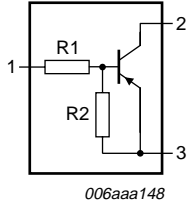
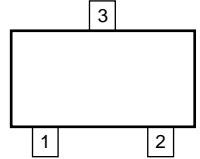
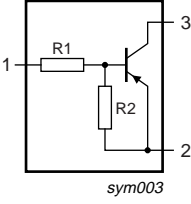
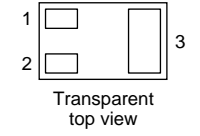
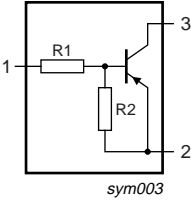
1.4 Quick reference data

Table 2. Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|------------------|---------------------------|------------|------|-----|------|------------|
| V _{CEO} | collector-emitter voltage | open base | - | - | -50 | V |
| I _O | output current (DC) | | - | - | -100 | mA |
| R1 | bias resistor 1 (input) | | 15.4 | 22 | 28.6 | k Ω |
| R2/R1 | bias resistor ratio | | 1.7 | 2.1 | 2.6 | |

2. Pinning information

Table 3. Pinning

| Pin | Description | Simplified outline | Symbol |
|--|--------------------|--|--|
| SOT54 | | | |
| 1 | input (base) |  <p>001aab347</p> |  <p>006aaa148</p> |
| 2 | output (collector) | | |
| 3 | GND (emitter) | | |
| SOT54A | | | |
| 1 | input (base) |  <p>001aab348</p> |  <p>006aaa148</p> |
| 2 | output (collector) | | |
| 3 | GND (emitter) | | |
| SOT54 variant | | | |
| 1 | input (base) |  <p>001aab447</p> |  <p>006aaa148</p> |
| 2 | output (collector) | | |
| 3 | GND (emitter) | | |
| SOT23; SOT323; SOT346; SOT416; SOT490 | | | |
| 1 | input (base) |  <p>006aaa144</p> |  <p>sym003</p> |
| 2 | GND (emitter) | | |
| 3 | output (collector) | | |
| SOT883 | | | |
| 1 | input (base) |  <p>Transparent top view</p> |  <p>sym003</p> |
| 2 | GND (emitter) | | |
| 3 | output (collector) | | |

3. Ordering information

Table 4. Ordering information

| Type number | Package | | Version |
|--------------------------|---------|---|---------|
| | Name | Description | |
| PDTA124XE | SC-75 | plastic surface mounted package; 3 leads | SOT416 |
| PDTA124XEF | SC-89 | plastic surface mounted package; 3 leads | SOT490 |
| PDTA124XK | SC-59A | plastic surface mounted package; 3 leads | SOT346 |
| PDTA124XM | SC-101 | leadless ultra small plastic package; 3 solder lands; body 1.0 × 0.6 × 0.5 mm | SOT883 |
| PDTA124XS ^[1] | SC-43A | plastic single-ended leaded (through hole) package; 3 leads | SOT54 |
| PDTA124XT | - | plastic surface mounted package; 3 leads | SOT23 |
| PDTA124XU | SC-70 | plastic surface mounted package; 3 leads | SOT323 |

[1] Also available in SOT54A and SOT54 variant packages (see [Section 2](#) and [Section 9](#))

4. Marking

Table 5. Marking codes

| Type number | Marking code ^[1] |
|-------------|-----------------------------|
| PDTA124XE | 31 |
| PDTA124XEF | 31 |
| PDTA124XK | 44 |
| PDTA124XM | DK |
| PDTA124XS | TA124X |
| PDTA124XT | *47 |
| PDTA124XU | *44 |

[1] * = -: made in Hong Kong
 * = p: made in Hong Kong
 * = t: made in Malaysia
 * = W: made in China

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit | |
|------------------|---------------------------|--------------------------|--------|------|------|----|
| V _{CBO} | collector-base voltage | open emitter | - | -50 | V | |
| V _{CEO} | collector-emitter voltage | open base | - | -50 | V | |
| V _{EBO} | emitter-base voltage | open collector | - | -7 | V | |
| V _I | input voltage | | | | | |
| | positive | | - | +7 | V | |
| | negative | | - | -40 | V | |
| I _O | output current (DC) | | - | -100 | mA | |
| I _{CM} | peak collector current | | - | -100 | mA | |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | | | | |
| | SOT416 | | [1] | - | 150 | mW |
| | SOT490 | | [1][2] | - | 250 | mW |
| | SOT346 | | [1] | - | 250 | mW |
| | SOT883 | | [2][3] | - | 250 | mW |
| | SOT54 | | [1] | - | 500 | mW |
| | SOT23 | | [1] | - | 250 | mW |
| | SOT323 | | [1] | - | 200 | mW |
| | T _{stg} | storage temperature | | -65 | +150 | °C |
| T _j | junction temperature | | - | 150 | °C | |
| T _{amb} | ambient temperature | | -65 | +150 | °C | |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 60 μ m copper strip line, standard footprint.

6. Thermal characteristics

Table 7. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------|---|-------------|--------|-----|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | | | | |
| | SOT416 | | [1] | - | 833 | K/W |
| | SOT490 | | [1][2] | - | 500 | K/W |
| | SOT346 | | [1] | - | 500 | K/W |
| | SOT883 | | [2][3] | - | 500 | K/W |
| | SOT54 | | [1] | - | 250 | K/W |
| | SOT23 | | [1] | - | 500 | K/W |
| | SOT323 | | [1] | - | 625 | K/W |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

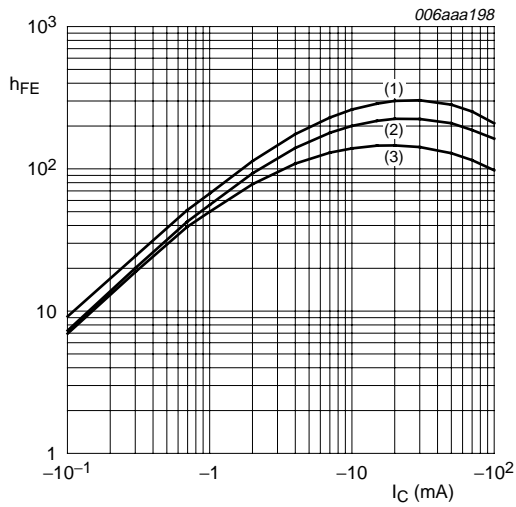
[3] Device mounted on an FR4 PCB with 60 μ m copper strip line, standard footprint.

7. Characteristics

Table 8. Characteristics

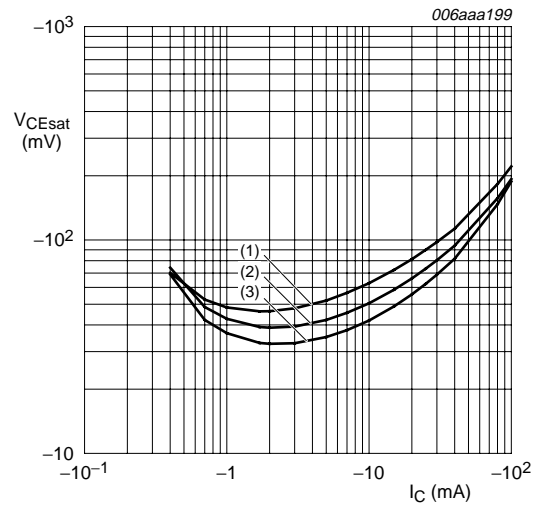
$T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------|--------------------------------------|---|------|------|------|------------|
| I_{CBO} | collector-base cut-off current | $V_{CB} = -50\text{ V}$; $I_E = 0\text{ A}$ | - | - | -100 | nA |
| I_{CEO} | collector-emitter cut-off current | $V_{CE} = -30\text{ V}$; $I_B = 0\text{ A}$ | - | - | -1 | μ A |
| | | $V_{CE} = -30\text{ V}$; $I_B = 0\text{ A}$; $T_j = 150\text{ }^{\circ}\text{C}$ | - | - | -50 | μ A |
| I_{EBO} | emitter-base cut-off current | $V_{EB} = -5\text{ V}$; $I_C = 0\text{ A}$ | - | - | -120 | μ A |
| h_{FE} | DC current gain | $V_{CE} = -5\text{ V}$; $I_C = -5\text{ mA}$ | 80 | - | - | |
| V_{CEsat} | collector-emitter saturation voltage | $I_C = -10\text{ mA}$; $I_B = -0.5\text{ mA}$ | - | - | -150 | mV |
| $V_{I(off)}$ | off-state input voltage | $V_{CE} = -5\text{ V}$; $I_C = -100\text{ }\mu\text{A}$ | - | -0.8 | -0.5 | V |
| $V_{I(on)}$ | on-state input voltage | $V_{CE} = -0.3\text{ V}$; $I_C = -2\text{ mA}$ | -2 | -1.1 | - | V |
| R1 | bias resistor 1 (input) | | 15.4 | 22 | 28.6 | k Ω |
| R2/R1 | bias resistor ratio | | 1.7 | 2.1 | 2.6 | |
| C_c | collector capacitance | $V_{CB} = -10\text{ V}$; $I_E = i_e = 0\text{ A}$; $f = 1\text{ MHz}$ | - | - | 3 | pF |



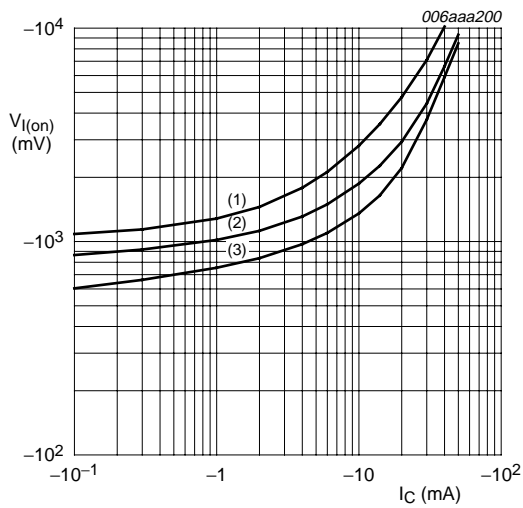
$V_{CE} = -5\text{ V}$
 (1) $T_{amb} = 100\text{ }^{\circ}\text{C}$
 (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$
 (3) $T_{amb} = -40\text{ }^{\circ}\text{C}$

Fig. 1. DC current gain as a function of collector current; typical values



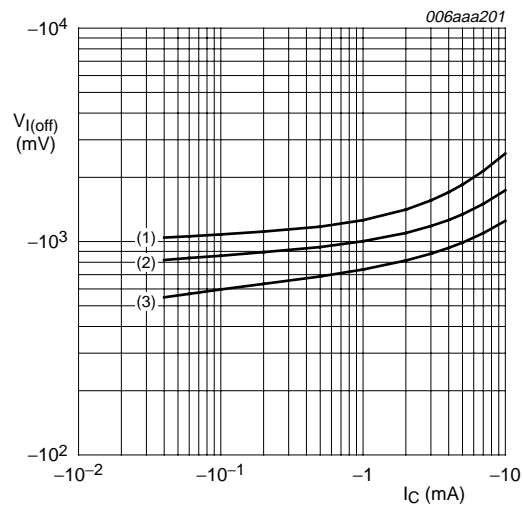
$I_C/I_B = 20$
 (1) $T_{amb} = 100\text{ }^{\circ}\text{C}$
 (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$
 (3) $T_{amb} = -40\text{ }^{\circ}\text{C}$

Fig. 2. Collector-emitter saturation voltage as a function of collector current; typical values



$V_{CE} = -0.3\text{ V}$
 (1) $T_{amb} = -40\text{ }^{\circ}\text{C}$
 (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$
 (3) $T_{amb} = 100\text{ }^{\circ}\text{C}$

Fig. 3. On-state input voltage as a function of collector current; typical values



$V_{CE} = -5\text{ V}$
 (1) $T_{amb} = -40\text{ }^{\circ}\text{C}$
 (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$
 (3) $T_{amb} = 100\text{ }^{\circ}\text{C}$

Fig. 4. Off-state input voltage as a function of collector current; typical values

8. Package outline

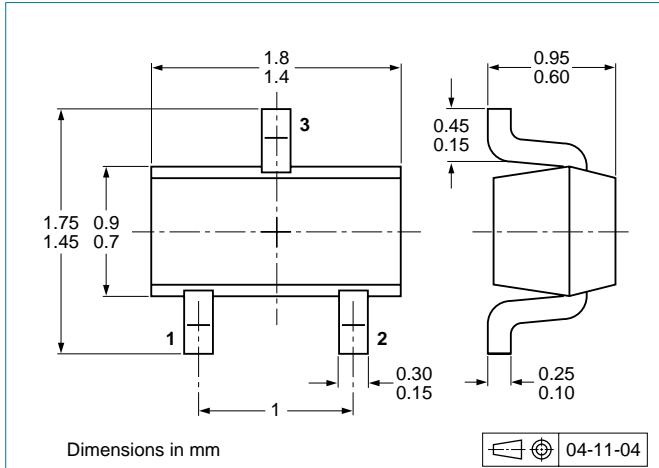


Fig 5. Package outline SOT416 (SC-75)

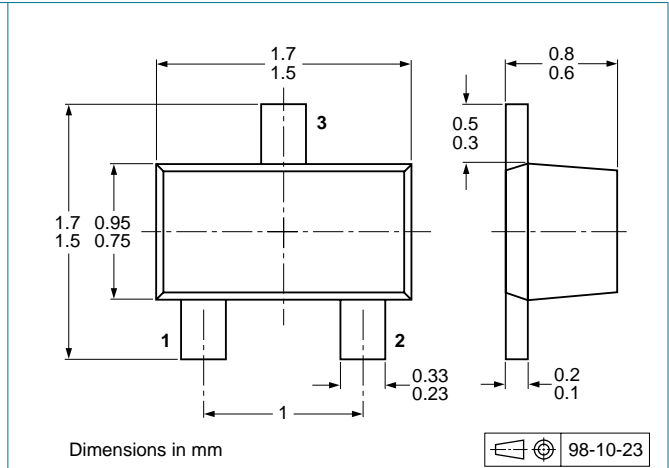


Fig 6. Package outline SOT490 (SC-89)

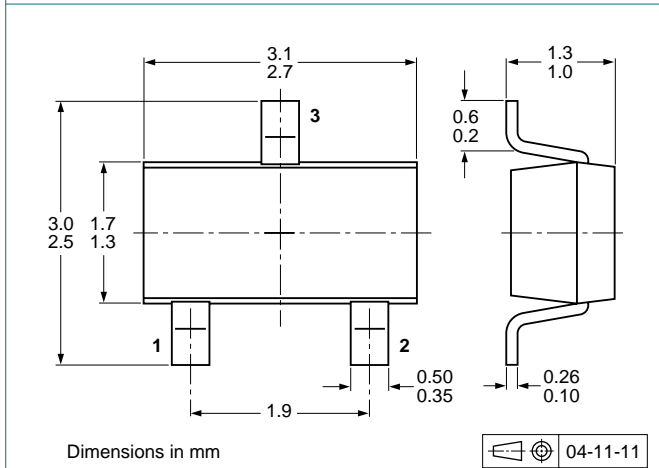


Fig 7. Package outline SOT346 (SC-59A/TO-236)

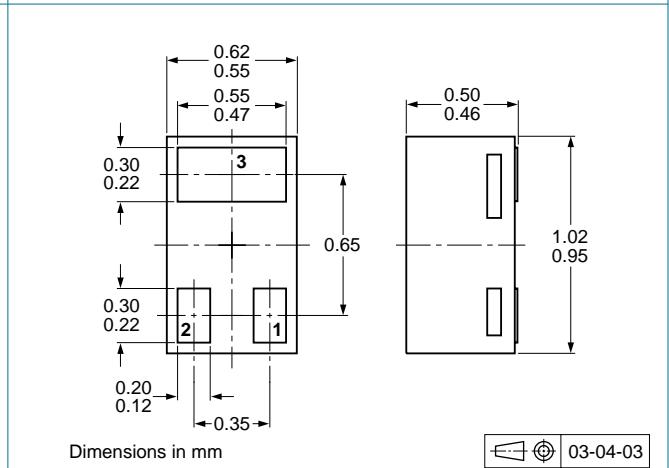


Fig 8. Package outline SOT883 (SC-101)

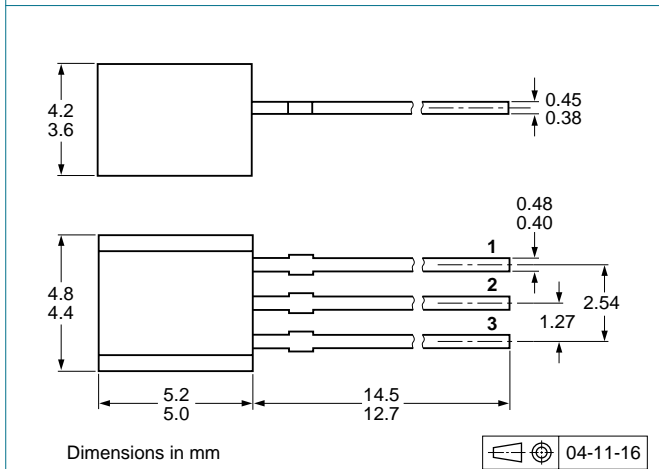


Fig 9. Package outline SOT54 (SC-43A/TO-92)

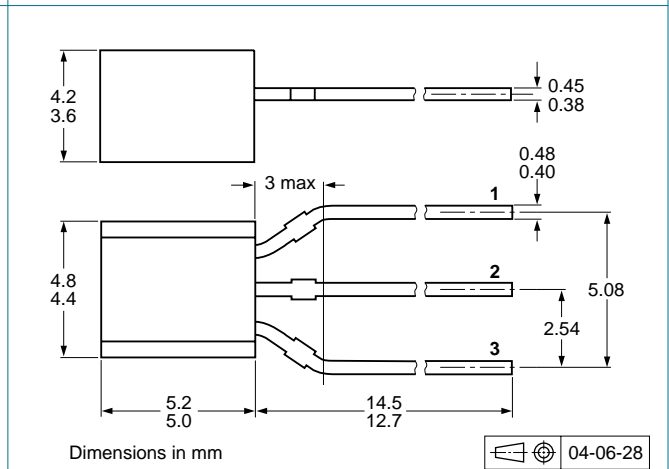


Fig 10. Package outline SOT54A

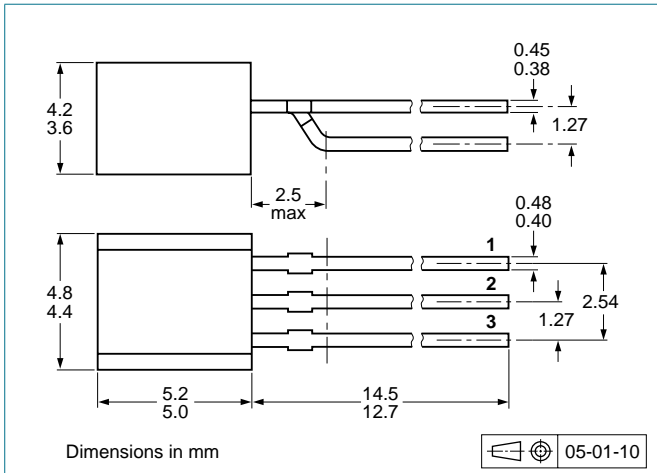


Fig 11. Package outline SOT54 variant

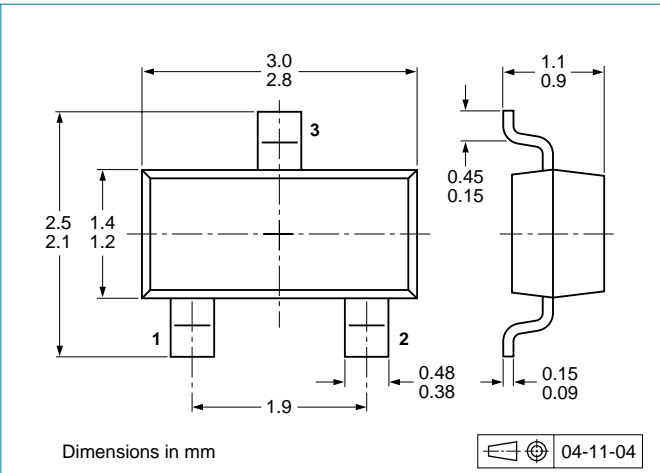


Fig 12. Package outline SOT23 (TO-236AB)

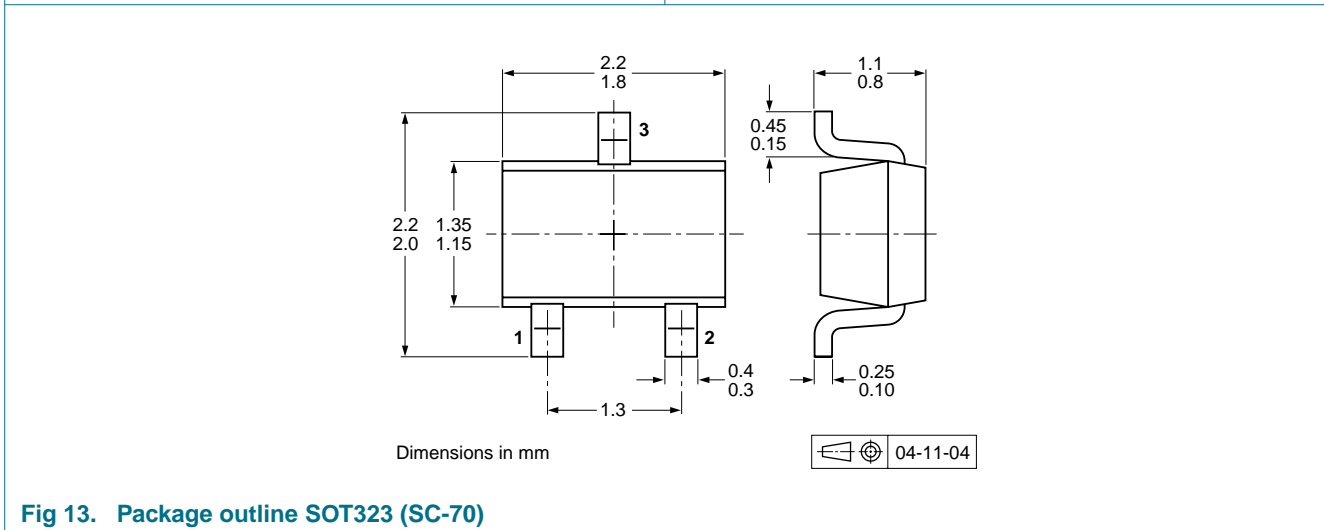


Fig 13. Package outline SOT323 (SC-70)

9. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.^[1]

| Type number | Package | Description | Packing quantity | | | |
|-------------|---------------|--------------------------------|------------------|------|------|-------|
| | | | 3000 | 4000 | 5000 | 10000 |
| PDTA124XE | SOT416 | 4 mm pitch, 8 mm tape and reel | -115 | - | - | -135 |
| PDTA124XEF | SOT490 | 4 mm pitch, 8 mm tape and reel | - | -115 | - | - |
| PDTA124XK | SOT346 | 4 mm pitch, 8 mm tape and reel | -115 | - | - | -135 |
| PDTA124XM | SOT883 | 2 mm pitch, 8 mm tape and reel | - | - | - | -315 |
| PDTA124XS | SOT54 | bulk, straight leads | - | - | -412 | - |
| | SOT54A | tape and reel, wide pitch | - | - | - | -116 |
| | | tape ammpack, wide pitch | - | - | - | -126 |
| | SOT54 variant | bulk, delta pinning | - | - | -112 | - |
| PDTA124XT | SOT23 | 4 mm pitch, 8 mm tape and reel | -215 | - | - | -235 |
| PDTA124XU | SOT323 | 4 mm pitch, 8 mm tape and reel | -115 | - | - | -135 |

[1] For further information and the availability of packing methods, see [Section 12](#).

10. Revision history

Table 10. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|-------------------|--|---------------------------|---------------|-----------------------------|
| PDTA124X_SER_8 | 20090903 | Product data sheet | - | PDTA124X_SER_7 |
| Modifications: | <ul style="list-style-type: none"> This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content | | | |
| PDTA124X_SER_7 | 20050811 | Product data sheet | - | PDTA124X_SERIES_6 |
| PDTA124X_SERIES_6 | 20040804 | Product specification | - | PDTA124X_SERIES_5 |
| PDTA124X_SERIES_5 | 20040407 | Product specification | - | PDTA124X_SERIES_4 |
| PDTA124X_SERIES_4 | 20030414 | Product specification | - | PDTA124XE_3 PDTA124XEF_2 |
| PDTA124XE_3 | 19990521 | Product specification | - | PDTA124XE_2 |
| PDTA124XE_2 | 19981125 | Product specification | - | PDTA124XE_1 |
| PDTA124XE_1 | 19971215 | Product specification | - | - |
| PDTA124XEF_2 | 19990525 | Preliminary specification | - | PDTA124XEF_1 |
| PDTA124XEF_1 | 19981116 | Preliminary specification | - | - |

11. Legal information

11.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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Date of release: 3 September 2009

Document identifier: PDTA124X_SER_8

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